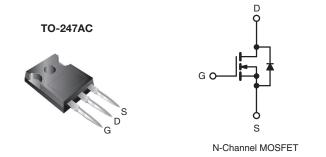


Power MOSFET

| PRODUCT SUMMARY | | | | | |
|----------------------------|------------------------|--------|--|--|--|
| V _{DS} (V) | 600 | 600 | | | |
| $R_{DS(on)}(\Omega)$ | V _{GS} = 10 V | 0.40 | | | |
| Q _g (Max.) (nC) | 210 |) | | | |
| Q _{gs} (nC) | 26 | | | | |
| Q _{gd} (nC) | 110 | 110 | | | |
| Configuration | Sing | Single | | | |



FEATURES

- · Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Isolated Central Mounting Hole
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC



DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance cost-effectiveness.

The TO-247AC package preferred commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because of its isolated mounting hole. It also provides greater creepage distance between pins to meet the requirements of most safety specifications.

| ORDERING INFORMATION | | | | |
|----------------------|-------------|--|--|--|
| Package | TO-247AC | | | |
| Lead (Pb)-free | IRFPC60PbF | | | |
| Lead (FD)-life | SiHFPC60-E3 | | | |
| SnPb | IRFPC60 | | | |
| OIII D | SiHFPC60 | | | |

| ABSOLUTE MAXIMUM RATINGS (T _C | = 25 °C, unl | ess otherwis | se noted) | | | |
|--|-------------------------|-------------------------|-----------------------------------|------------------|----------|--|
| PARAMETER | | | SYMBOL | LIMIT | UNIT | |
| Drain-Source Voltage | | | V_{DS} | 600 | V | |
| Gate-Source Voltage | | | V_{GS} | ± 20 | | |
| Continuous Drain Current | V _{GS} at 10 V | T _C = 25 °C | - I _D | 16 | | |
| | | T _C = 100 °C | | 10 | Α | |
| Pulsed Drain Current ^a | | | I _{DM} | 64 | | |
| Linear Derating Factor | | | | 2.2 | W/°C | |
| Single Pulse Avalanche Energy ^b | | | E _{AS} | 1000 | mJ | |
| Repetitive Avalanche Current ^a | | | I _{AR} | 16 | А | |
| Repetitive Avalanche Energy ^a | | | E _{AR} | 28 | mJ | |
| Maximum Power Dissipation | T _C = | 25 °C | P_{D} | 280 | W | |
| Peak Diode Recovery dV/dt ^c | | | dV/dt | 3.0 | V/ns | |
| Operating Junction and Storage Temperature Range | | | T _J , T _{stg} | - 55 to + 150 | °C | |
| Soldering Recommendations (Peak Temperature) | for 10 s | | | 300 ^d |] | |
| Mounting Torque | 6-32 or M3 screw | | | 10 | lbf ⋅ in | |
| | | | | 1.1 | N · m | |

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 7.2 mH, R_g = 25 Ω , I_{AS} = 16 A (see fig. 12).
- c. $I_{SD} \le 16$ A, $dI/dt \le 140$ A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply



| THERMAL RESISTANCE RATINGS | | | | | |
|-------------------------------------|-------------------|------|------|------|--|
| PARAMETER | SYMBOL | TYP. | MAX. | UNIT | |
| Maximum Junction-to-Ambient | R _{thJA} | - | 40 | | |
| Case-to-Sink, Flat, Greased Surface | R _{thCS} | 0.24 | - | °C/W | |
| Maximum Junction-to-Case (Drain) | R _{thJC} | - | 0.45 | | |

| PARAMETER | SYMBOL | TES | MIN. | TYP. | MAX. | UNIT | |
|---|-----------------------|--|--|------|------|-------|-------|
| Static | | | | | | • | ' |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | | 600 | - | - | V |
| V _{DS} Temperature Coefficient | $\Delta V_{DS}/T_{J}$ | Reference | e to 25 °C, I _D = 1 mA | - | 830 | - | mV/°C |
| Gate-Source Threshold Voltage | V _{GS(th)} | V _{DS} : | = V _{GS} , I _D = 250 μA | 2.0 | - | 4.0 | V |
| Gate-Source Leakage | I _{GSS} | V _{GS} = ± 20 V | | - | - | ± 100 | nA |
| Zoro Cata Voltago Drain Current | 1 | V _{DS} : | = 600 V, V _{GS} = 0 V | - | - | 100 | |
| Zero Gate Voltage Drain Current | | | _S = 480 V, V _{GS} = 0 V, T _J = 125 °C | | - | 500 | μA |
| Drain-Source On-State Resistance | R _{DS(on)} | V _{GS} = 10 V | $I_D = 9.6 A^b$ | - | - | 0.40 | Ω |
| Forward Transconductance | 9 _{fs} | V _{DS} | $= 50 \text{ V}, I_D = 9.6 \text{ A}^b$ | 13 | - | - | S |
| Dynamic | | | | | | | |
| Input Capacitance | C _{iss} | $V_{GS} = 0 \text{ V}, \\ V_{DS} = 25 \text{ V}, \\ f = 1.0 \text{ MHz, see fig. 5}$ | | - | 3900 | - | pF |
| Output Capacitance | C _{oss} | | | - | 440 | - | |
| Reverse Transfer Capacitance | C_{rss} | | | - | 98 | - | |
| Total Gate Charge | Qg | | | - | - | 210 | nC |
| Gate-Source Charge | Q _{gs} | V _{GS} = 10 V | $I_D = 16 \text{ A}, V_{DS} = 360 \text{ V},$ see fig. 6 and 13^b | - | - | 26 | |
| Gate-Drain Charge | $Q_{\sf gd}$ | | coo ng. o ana 10 | - | - | 110 | |
| Turn-On Delay Time | t _{d(on)} | V_{DD} = 300 V, I_{D} = 16 A, R_{g} = 4.5 Ω, R_{D} = 18 Ω see fig. 10 ^b | | - | 19 | - | - ns |
| Rise Time | t _r | | | - | 54 | - | |
| Turn-Off Delay Time | t _{d(off)} | | | - | 110 | - | |
| Fall Time | t _f | | | - | 56 | - | |
| Internal Drain Inductance | L_D | Between lead, 6 mm (0.25") from package and center of die contact | | - | 5.0 | - | nH |
| Internal Source Inductance | L _S | | | - | 13 | - | |
| Drain-Source Body Diode Characteristic | s | | | | | • | 1 |
| Continuous Source-Drain Diode Current | Is | MOSFET symbol showing the integral reverse p - n junction diode | | - | - | 16 | |
| Pulsed Diode Forward Current ^a | I _{SM} | | | - | - | 64 | A |
| Body Diode Voltage | V _{SD} | T _J = 25 °C, I _S = 16 A, V _{GS} = 0 V ^b | | - | - | 1.8 | V |
| Body Diode Reverse Recovery Time | t _{rr} | T _J = 25 °C, I _F = 16 A, dl/dt = 100 A/μs ^b | | - | 610 | 920 | ns |
| Body Diode Reverse Recovery Charge | Q _{rr} | | | - | 6.6 | 9.9 | μC |
| Forward Turn-On Time | t _{on} | Intrinsic turn-on time is negligible (turn-on is dominated by L _S and | | | | l Ln) | |

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

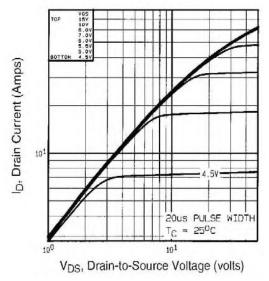


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

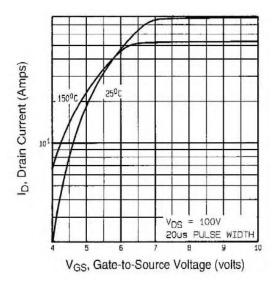


Fig. 3 - Typical Transfer Characteristics

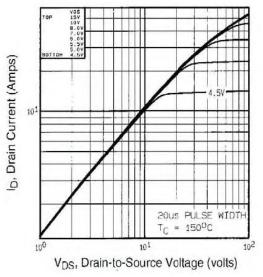


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

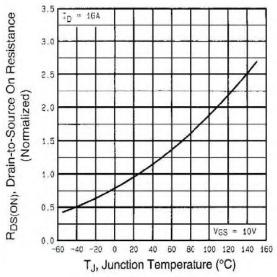


Fig. 4 - Normalized On-Resistance vs. Temperature



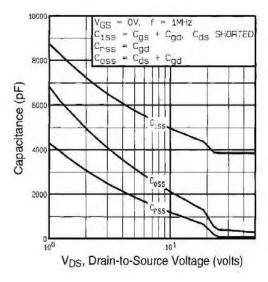


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

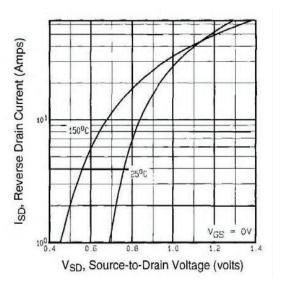


Fig. 7 - Typical Source-Drain Diode Forward Voltage

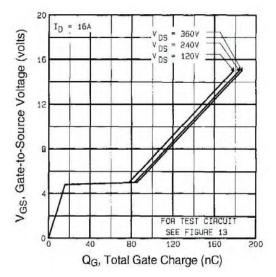


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

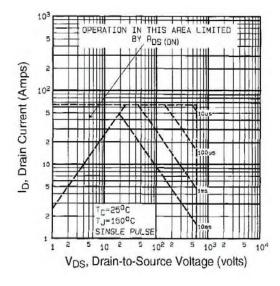


Fig. 8 - Maximum Safe Operating Area





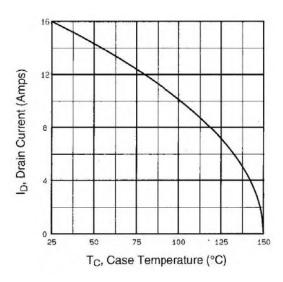


Fig. 9 - Maximum Drain Current vs. Case Temperature

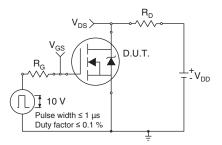


Fig. 10a - Switching Time Test Circuit

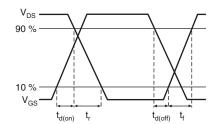


Fig. 10b - Switching Time Waveforms

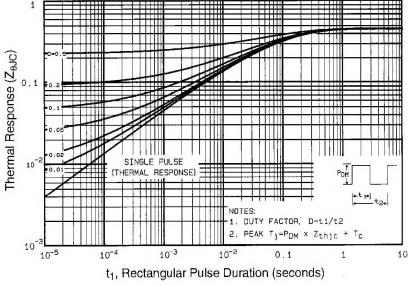


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



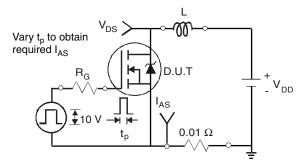


Fig. 12a - Unclamped Inductive Test Circuit

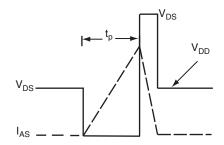


Fig. 12b - Unclamped Inductive Waveforms

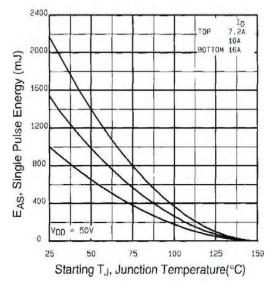


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

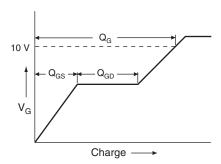


Fig. 13a - Basic Gate Charge Waveform

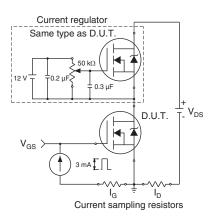
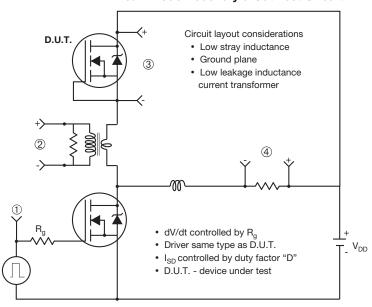


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



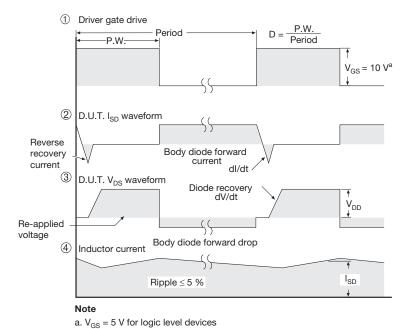


Fig. 14 - For N-Channel

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